

05-11-1998

FORM PTO-1595  
(Rev. 6-93)



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PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE  
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MRD  
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Attorney Docket No.: 040894-5313

To the Assistant Commissioner for Patents:  
Please record the attached original documents or copy thereof.

ATTN: BOX ASSIGNMENT

1. Name of conveying party(ies):

Hideki OHSUMI

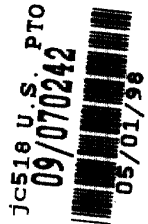
Additional name(s) of conveying party(ies) attached?

Yes  No

2. Name and address of receiving party(ies):

Name: YAZAKI CORPORATION

Internal Address:



Street Address: 4-28, Mita 1-chome, Minato-ku,  
Tokyo, Japan

City:

State:

Zip:

Additional name(s) & address(es) attached?

Yes  No

3. Nature of conveyance:

Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_

Execution Date: April 20, 1998

4. Application number(s) or patent number(s):

09/070242

If this document is being filed together with a new application the execution date of the application is:

April 20, 1998

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached:  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Robert J. Gaybrick

Internal Address: Morgan, Lewis & Bockius LLP

Street Address: 1800 M Street, N.W.

City: Washington State: D.C. Zip: 20036

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R §3.41): \$40.00

Enclosed

Authorized to be charged to deposit account 50-0310

8. Deposit account number: 50-0310

Attach duplicate of page if paying by deposit account

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

J. Michael Thesz

Name of Person Signing

Signature

May 1, 1998

Date

05/08/1998 SSMITH 00000028 09070242

Total number of pages including cover sheet, attachments and documents: 2

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ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

CONNECTOR

for which I/WE executed an application for United States Letters Patent concurrently herewith; or on April 20, 1998; or filed an application for United States Letters Patent on \_\_\_\_\_, (Serial No. \_\_\_\_\_); and

WHEREAS, YAZAKI CORPORATION, a corporation of Japan, whose post office address is 4-28, Mita 1-chome, Minato-ku, Tokyo, Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. \_\_\_\_\_, filed \_\_\_\_\_) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

1. Full Name of Sole of First Assignor Hideki Ohsumi	Assignor's Signature <i>Hideki Ohsumi</i>	Date April 20, 1998
Address Shizuoka, Japan		Citizenship Japan
2. Full Name of Second Assignor	Assignor's Signature	Date
Address		Citizenship

MORGAN, LEWIS & BOCKIUS